Heraeus

Technical Data Sheet



ASSEMBLY MATERIALS

Product Type: SMT Adhesive

Product Name: PD 205 A-Jet

Description

PD 205 A-Jet is a thermosetting single component, solvent-free polymer adhesive, developed especially for the surface mount of SMT components onto PCBs and for use on bare substrates. This rheology is specially adapted for Jet dispensing

Key Benefits

- Very wide processing window, no tendency towards stringing
- Rheology is especially developed for Jet dispensing

Applications

- Dispensing
- Jetting

Physical Properties

Processing time at 20 – 30°C (days)	Curing Profile				Colour
Max. 2	The standard curing conditions are 125°C / 3 minutes. Max curing temperature should not be higher than 200°C..				Red
	Temperature (°C)				
	100	125	150	180	
	Time (min)				
	8	3	1.5	1	

Cleaning Instructions

Before curing: The adhesive can be removed with Zestron HC and other Zestron and Vigon cleaning materials. Do not use alcohol as this will cure the adhesive. Cleaned dispensing units should be completely dried before installation.
After Curing: Defective components can be replaced by heating (with hot air) the cured adhesive joint above 100 °C. After removing the component (torsion movement), the hot air should be focused on the remaining adhesive in order to remove it with a sharp tool.

Adhesive Conditioning

- Remove adhesive from fridge: Before opening the package leave it for at least 2 hours at room temperature so that adhesive heats up
- Do not open jar/cartridge while adhesive is cold to prevent condensation
- Before using adhesive cartridge: Before inserting nozzle, press small quantity of glue out of cartridge until homogeneous glue comes out – during storage of cartridges, low viscosity glue constituents may be found on the tip of the cartridge

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Storage

- Store the SMT-adhesive in originally-sealed containers and avoid exposure to high humidity and sunlight
- Store cartridges with tip pointing downwards
- Max. expiration date: Shelf life: Please refer to the expiry date on the label of the packaged product
- Storage condition in the refrigerator at 2 – 10 °C

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